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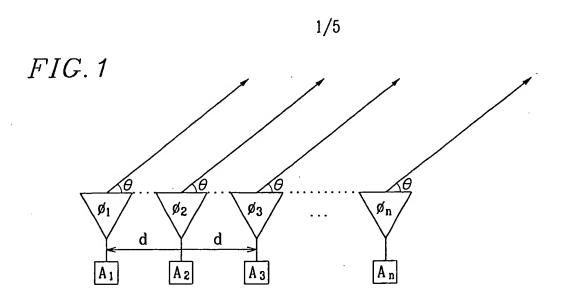


FIG. 2A

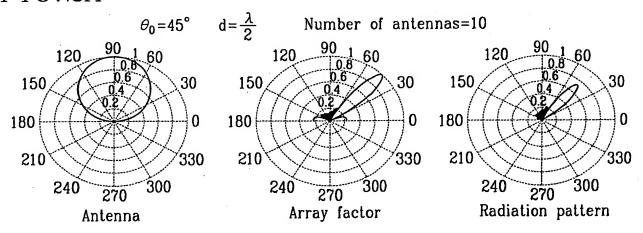
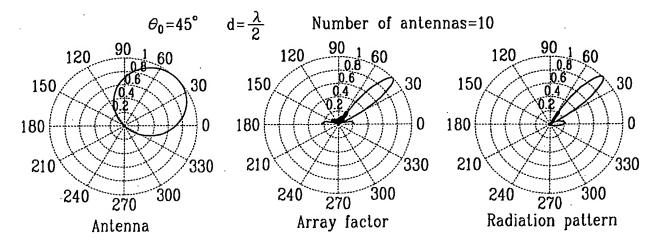


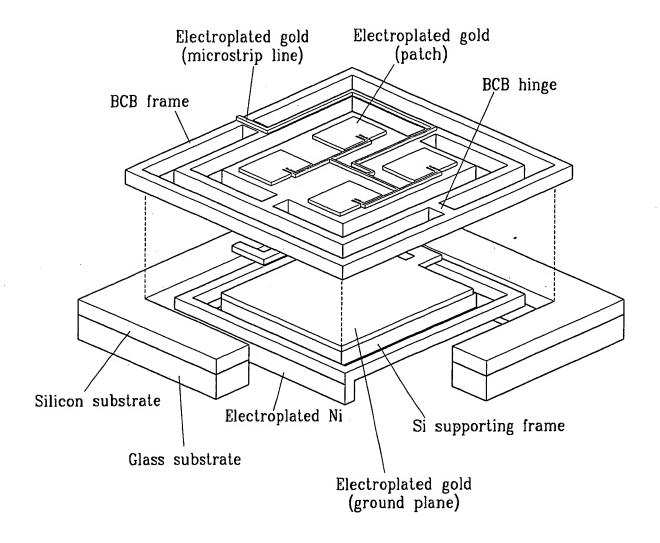
FIG. 2B



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FIG. 3



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FIG. 4A

Glass

* Anodic bonding of glass & silicon

* Thinning of silicon using KOH

* CMP of silicon

FIG.4B

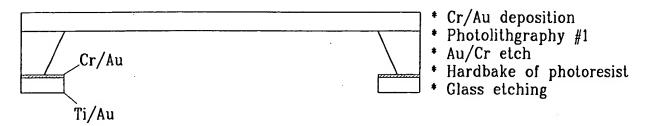


FIG. 4C

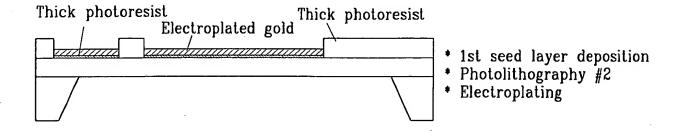
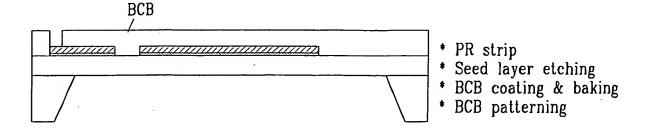


FIG. 4D



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FIG. 4E

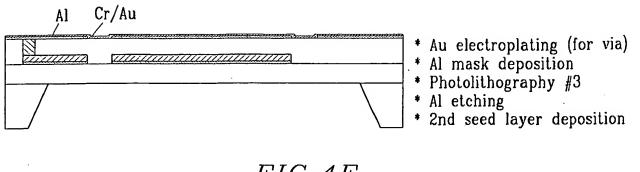


FIG.4F

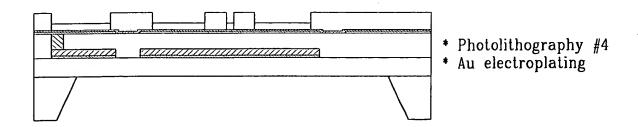


FIG.4G

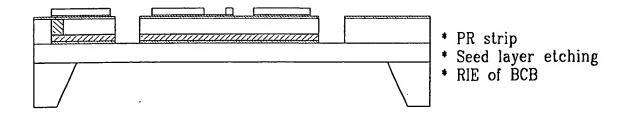


FIG. 4H

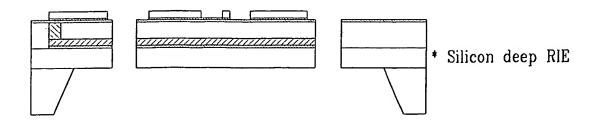


FIG. 5

